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PATENT
Docket No. 1948-4631

AF
3101

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : NICOLAI et al. Group Art Unit: 3729

Serial No. : 09/423,075 Examiner: S. Smith

Filed : November 1, 1999

For : SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT
MOUNTED ON A METAL SUBSTRATE

CERTIFICATE OF MAILING (37 C.F.R. 1.8a)

Commissioner for Patents
Washington, D.C. 20231

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Sir:

AUG 19 2002

I hereby certify that the following attached papers

TECHNOLOGY CENTER R3700

1. Amendment under 37 C.F.R. § 1.116; and
2. Return postcard.

(along with any papers referred to as being attached or enclosed) and this Certificate of Mailing are being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the: Commissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

MORGAN & FINNEGAN

Date: August 8, 2002

By:
Richard D. Ratchford Jr.

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H/12/E
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For: SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT MOUNTED
ON A METAL SUBSTRATE

AMENDMENT UNDER 37 C.F.R. § 1.116

Commissioner for Patents
Washington, DC 20231
Box AF

Sir:

This Amendment Under 37 C.F.R. § 1.116 is submitted in response to the Final
Rejection dated May 8, 2002. Applicants respectfully request consideration of the above-
identified application in view of the following amendments and remarks.

Please amend this application as follows. An appendix hereto shows the claim
amendments with interlineations and deletions.

IN THE CLAIMS

E1
Please AMEND claim 4 as follows:

4. (Amended) A method of producing an assembly comprising a printed-circuit
electronics card mounted on a metal substrate with a metal screening cover electrically
connected to the substrate, the method comprising:

forming a gutter on a metallic substrate by stamping;

8/20/02
W/J Best
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